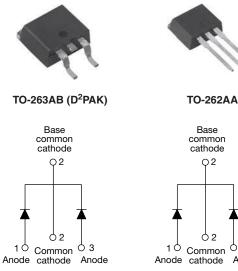
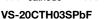


www.vishay.com

## Hyperfast Rectifier, 2 x 10 A FRED Pt<sup>®</sup>





03 Anode cathode Anode VS-20CTH03-1PbF

| PRODUCT SUMMARY                  |   |
|----------------------------------|---|
| Package                          | TO-263AB (D <sup>2</sup> PAK), TO-262AA |
| I <sub>F(AV)</sub>               | 2 x 10 A                                |
| V <sub>R</sub>                   | 300 V                                   |
| V <sub>F</sub> at I <sub>F</sub> | 0.85 V                                  |
| t <sub>rr</sub> max.             | 35 ns                                   |
| T <sub>J</sub> max.              | 175 °C                                  |
| Diode variation                  | Common cathode                          |

#### **FEATURES**

- Hyperfast recovery time
- · Low forward voltage drop
- Low leakage current
- 175 °C operating junction temperature
- Meets MSL level 1, per J-STD-020, LF maximum COMPLIANT HALOGEN peak of 260 °C FREE
- AEC-Q101 gualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **DESCRIPTION / APPLICATIONS**

Vishay Semiconductors 300 V series are the state of the art hyperfast recovery rectifiers designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, UPS, DC/DC converters as well as freewheeling diode in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

| ABSOLUTE MAXIMUM RATINGS           |            |                                   |                         |             |       |  |
|------------------------------------|------------|-----------------------------------|-------------------------|-------------|-------|--|
| PARAMETER                          |            | SYMBOL                            | TEST CONDITIONS         | MAX.        | UNITS |  |
| Peak repetitive reverse voltage    |            | V <sub>RRM</sub>                  |                         | 300         | V     |  |
| Average rectified forward current  | per diode  | 1                                 | T <sub>C</sub> = 160 °C | 10          |       |  |
| Average rectilied forward current  | per device | IF(AV)                            |                         | 20          | А     |  |
| Non-repetitive peak surge current  |            | I <sub>FSM</sub>                  | T <sub>J</sub> = 25 °C  | 120         |       |  |
| Operating junction and storage ter | nperatures | T <sub>J</sub> , T <sub>Stg</sub> |                         | -65 to +175 | °C    |  |

| ELECTRICAL SPECIFICATIONS (T <sub>J</sub> = 25 °C unless otherwise specified) |                                     |   |      |      |      |       |
|---|-------------------------------------|---|------|------|------|-------|
| PARAMETER   | SYMBOL                              | TEST CONDITIONS                                 | MIN. | TYP. | MAX. | UNITS |
| Breakdown voltage,<br>blocking voltage  | V <sub>BR</sub> ,<br>V <sub>R</sub> | I <sub>R</sub> = 100 μA                         | 300  | -    | -    |       |
| Forward valtage   | V                                   | I <sub>F</sub> = 10 A                           | -    | 1.05 | 1.25 | V     |
| Forward voltage   | V <sub>F</sub>                      | I <sub>F</sub> = 10 A, T <sub>J</sub> = 125 °C  | -    | 0.85 | 0.95 |       |
| Reverse leakage current   |                                     | $V_{R} = V_{R}$ rated                           | -    | -    | 20   |       |
| neverse leakage current   | I <sub>R</sub>                      | $T_J = 125 \text{ °C}, V_R = V_R \text{ rated}$ | -    | 6    | 200  | μA    |
| Junction capacitance  | CT                                  | V <sub>R</sub> = 300 V                          | -    | 30   | -    | pF    |
| Series inductance   | L <sub>S</sub>                      | Measured lead to lead 5 mm from package body    | -    | 8    | -    | nH    |

Revision: 09-Jul-15

1

Document Number: 94011

For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000







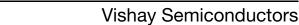
www.vishay.com

### Vishay Semiconductors

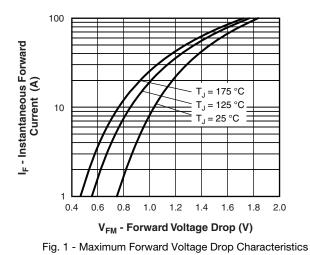
| <b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_c = 25 \text{ °C}$ unless otherwise specified) |                  |   |  |      |      |      |       |
|---|------------------|---|--|------|------|------|-------|
| PARAMETER   | SYMBOL           | TEST CO   | NDITIONS   | MIN. | TYP. | MAX. | UNITS |
|   |                  | $I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t =$ | $I_F$ = 1.0 A, $dI_F/dt$ = 50 A/µs, $V_R$ = 30 V         |      | -    | 35   |       |
| Bayaraa raaayara tima   | +                | $I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t =$ | 100 A/µs, V <sub>R</sub> = 30 V                          | -    | -    | 30   | ns    |
| Reverse recovery time   | t <sub>rr</sub>  | T <sub>J</sub> = 25 °C                          |  | -    | 31   | -    |       |
|   |                  | T <sub>J</sub> = 125 °C                         |  | -    | 42   | -    |       |
| Deck receiver a surrent   | 1                | T <sub>J</sub> = 25 °C                          | $I_{\rm F} = 10  {\rm A}$                                | -    | 2.4  | -    |       |
| Peak recovery current   | I <sub>RRM</sub> | T <sub>J</sub> = 125 °C                         | dI <sub>F</sub> /dt = 200 A/µs<br>V <sub>R</sub> = 200 V | -    | 5.6  | -    | A     |
|   | 0                | T <sub>J</sub> = 25 °C                          |  | -    | 36   | -    |       |
| Reverse recovery charge   | Q <sub>rr</sub>  | T <sub>J</sub> = 125 °C                         | ]  | -    | 120  | -    | nC    |

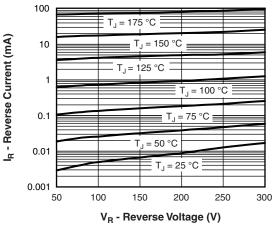
| THERMAL - MECHANICAL SPECIFICATIONS               |                                   |  |           |      |      |            |  |
|---|-----------------------------------|--|-----------|------|------|------------|--|
| PARAMETER   | SYMBOL                            | TEST CONDITIONS                          | MIN.      | TYP. | MAX. | UNITS      |  |
| Maximum junction and storage temperature range    | T <sub>J</sub> , T <sub>Stg</sub> |  | -65       | -    | 175  | °C         |  |
| Thermal resistance,<br>junction to case per diode | R <sub>thJC</sub>                 |  | -         | -    | 1.5  | °C/W       |  |
| Weight  |                                   |  | -         | 2.0  | -    | g          |  |
| Weight  |                                   |  | -         | 0.07 | -    | oz.        |  |
| Mounting torgue                                   |                                   |  | 6.0       | _    | 12   | kgf · cm   |  |
| Mounting torque                                   |                                   |  | (5.0)     |      | (10) | (lbf ⋅ in) |  |
| Marking dovice                                    |                                   | Case style TO-263AB (D <sup>2</sup> PAK) |           | 20CT | H03S |            |  |
| Marking device                                    |                                   | Case style TO-262AA                      | 20CTH03-1 |      |      |            |  |

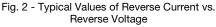
2











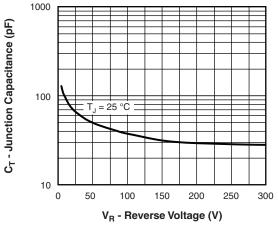


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

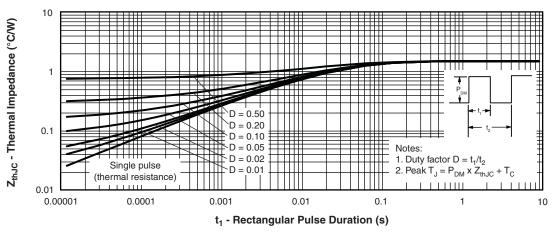
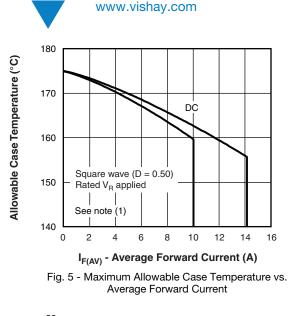


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics

Revision: 09-Jul-15 3 Document Number: 94011 For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

### **Vishay Semiconductors**



ISHAY

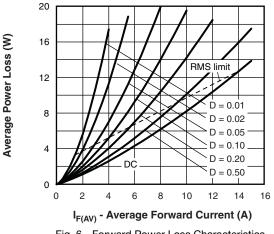
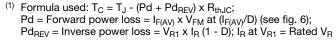
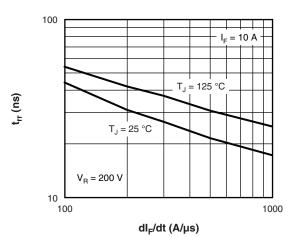


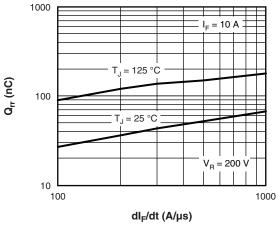
Fig. 6 - Forward Power Loss Characteristics

#### Note











 Revision: 09-Jul-15
 4
 Document Number: 94011

 For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com
 DiodesEurope@vishay.com

 THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



**Vishay Semiconductors** 

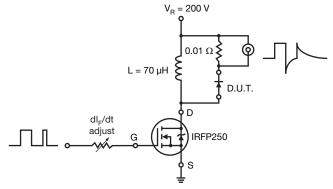
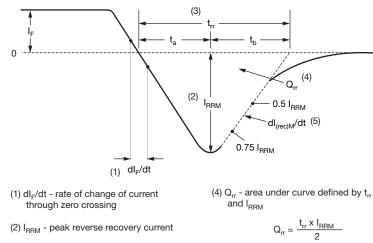


Fig. 9 - Reverse Recovery Parameter Test Circuit



(3)  $\mathrm{t}_{\mathrm{rr}}$  - reverse recovery time measured from zero crossing point of negative going  $I_F$  to point where a line passing through 0.75 I<sub>RRM</sub> and 0.50 I<sub>RRM</sub> extrapolated to zero current.

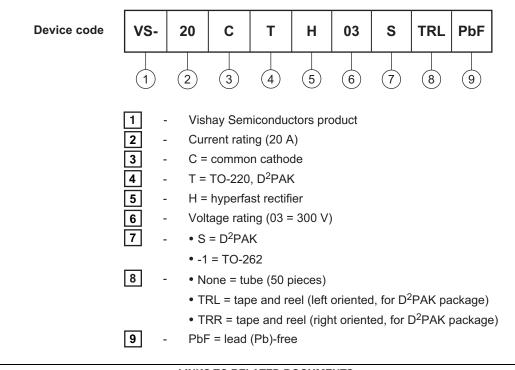
(5) dl<sub>(rec)M</sub>/dt - peak rate of change of current during t<sub>b</sub> portion of t<sub>rr</sub>

Fig. 10 - Reverse Recovery Waveform and Definitions



### **Vishay Semiconductors**

#### **ORDERING INFORMATION TABLE**



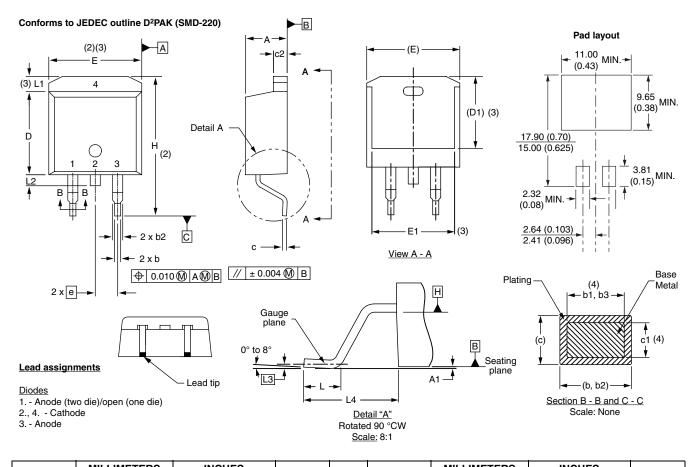
| LINKS TO RELATED DOCUMENTS |                          |  |  |  |  |  |
|----------------------------|--------------------------|--|--|--|--|--|
| Dimensions                 | www.vishay.com/doc?95014 |  |  |  |  |  |
| Part marking information   | www.vishay.com/doc?95008 |  |  |  |  |  |
| Packaging information      | www.vishay.com/doc?95032 |  |  |  |  |  |

Vishay High Power Products

# D<sup>2</sup>PAK, TO-262

#### DIMENSIONS FOR D<sup>2</sup>PAK in millimeters and inches

SHA



| SYMBOL | MILLIMETERS |       | INC   | INCHES |       |
|--------|-------------|-------|-------|--------|-------|
| STMBOL | MIN.        | MAX.  | MIN.  | MAX.   | NOTES |
| А      | 4.06        | 4.83  | 0.160 | 0.190  |       |
| A1     | 0.00        | 0.254 | 0.000 | 0.010  |       |
| b      | 0.51        | 0.99  | 0.020 | 0.039  |       |
| b1     | 0.51        | 0.89  | 0.020 | 0.035  | 4     |
| b2     | 1.14        | 1.78  | 0.045 | 0.070  |       |
| b3     | 1.14        | 1.73  | 0.045 | 0.068  | 4     |
| с      | 0.38        | 0.74  | 0.015 | 0.029  |       |
| c1     | 0.38        | 0.58  | 0.015 | 0.023  | 4     |
| c2     | 1.14        | 1.65  | 0.045 | 0.065  |       |
| D      | 8.51        | 9.65  | 0.335 | 0.380  | 2     |

| SYMBOL | MILLIM   | ETERS | INC   | HES   | NOTES |
|--------|----------|-------|-------|-------|-------|
| STMBOL | MIN.     | MAX.  | MIN.  | MAX.  | NOTES |
| D1     | 6.86     | 8.00  | 0.270 | 0.315 | 3     |
| E      | 9.65     | 10.67 | 0.380 | 0.420 | 2, 3  |
| E1     | 7.90     | 8.80  | 0.311 | 0.346 | 3     |
| е      | 2.54 BSC |       | 0.100 | BSC   |       |
| Н      | 14.61    | 15.88 | 0.575 | 0.625 |       |
| L      | 1.78     | 2.79  | 0.070 | 0.110 |       |
| L1     | -        | 1.65  | -     | 0.066 | 3     |
| L2     | 1.27     | 1.78  | 0.050 | 0.070 |       |
| L3     | 0.25 BSC |       | 0.010 | BSC   |       |
| L4     | 4.78     | 5.28  | 0.188 | 0.208 |       |
|        |          |       |       |       |       |

<sup>(7)</sup> Outline conforms to JEDEC outline TO-263AB

#### Notes

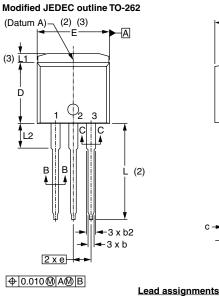
- <sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- $^{(3)}\,$  Thermal pad contour optional within dimension E, L1, D1 and E1
- <sup>(4)</sup> Dimension b1 and c1 apply to base metal only
- <sup>(5)</sup> Datum A and B to be determined at datum plane H
- <sup>(6)</sup> Controlling dimension: inch

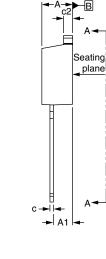
**Vishay High Power Products** 

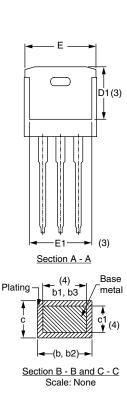
D<sup>2</sup>PAK, TO-262



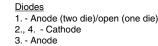
#### DIMENSIONS FOR TO-262 in millimeters and inches







Lead tip



| SYMBOL | MILLIM | IETERS | INCH  | INCHES |       |  |
|--------|--------|--------|-------|--------|-------|--|
|        | MIN.   | MAX.   | MIN.  | MAX.   | NOTES |  |
| А      | 4.06   | 4.83   | 0.160 | 0.190  |       |  |
| A1     | 2.03   | 3.02   | 0.080 | 0.119  |       |  |
| b      | 0.51   | 0.99   | 0.020 | 0.039  |       |  |
| b1     | 0.51   | 0.89   | 0.020 | 0.035  | 4     |  |
| b2     | 1.14   | 1.78   | 0.045 | 0.070  |       |  |
| b3     | 1.14   | 1.73   | 0.045 | 0.068  | 4     |  |
| С      | 0.38   | 0.74   | 0.015 | 0.029  |       |  |
| c1     | 0.38   | 0.58   | 0.015 | 0.023  | 4     |  |
| c2     | 1.14   | 1.65   | 0.045 | 0.065  |       |  |
| D      | 8.51   | 9.65   | 0.335 | 0.380  | 2     |  |
| D1     | 6.86   | 8.00   | 0.270 | 0.315  | 3     |  |
| E      | 9.65   | 10.67  | 0.380 | 0.420  | 2, 3  |  |
| E1     | 7.90   | 8.80   | 0.311 | 0.346  | 3     |  |
| е      | 2.54   | BSC    | 0.100 | BSC    |       |  |
| L      | 13.46  | 14.10  | 0.530 | 0.555  |       |  |
| L1     | -      | 1.65   | -     | 0.065  | 3     |  |
| L2     | 3.56   | 3.71   | 0.140 | 0.146  |       |  |

#### Notes

- <sup>(1)</sup> Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- <sup>(3)</sup> Thermal pad contour optional within dimension E, L1, D1 and E1

<sup>(4)</sup> Dimension b1 and c1 apply to base metal only

<sup>(5)</sup> Controlling dimension: inches

<sup>(6)</sup> Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline

www.vishay.com 2



Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.